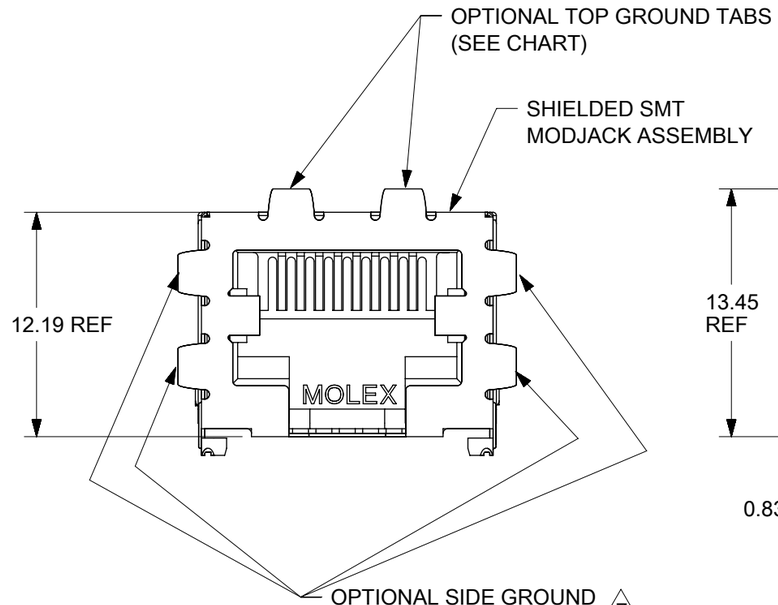
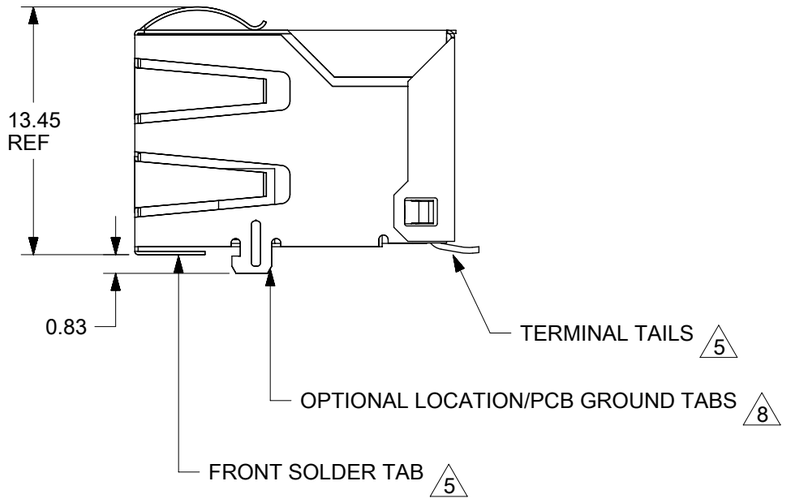
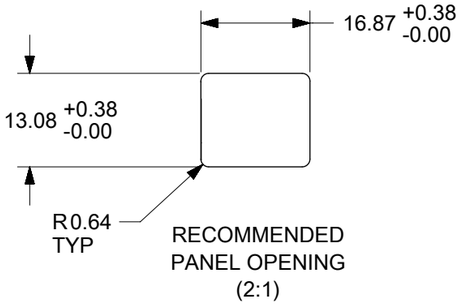
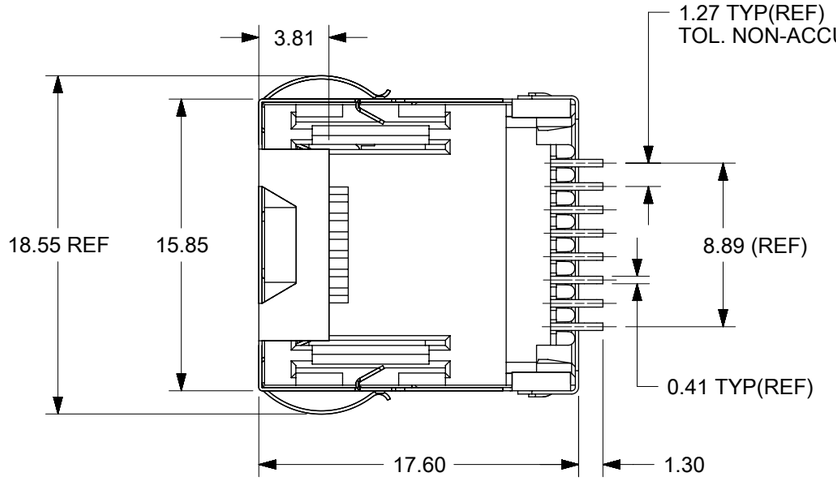
NOTES:
1) MATERIAL:
HOUSING & INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE, 0.30 mm THICK
SHIELD: BRASS
2) FINISH:
TERMINALS:
A = SELECT GOLD IN CONTACT AREA: 0.00127 mm MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: 0.00254 mm MIN.,
WITH OVERALL NICKEL UNDERPLATE: 0.00127 mm MIN.
B = SELECT GOLD IN CONTACT AREA: 0.00076 mm MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: 0.00254 mm MIN.,
WITH OVERALL NICKEL UNDERPLATE: 0.00127 mm MIN.
C = SELECT GOLD IN CONTACT AREA: 0.00038 mm MIN.,
*SELECT MATTE TIN IN PC TAIL AREA: 0.00254 mm MIN.,
WITH OVERALL NICKEL UNDERPLATE: 0.00127 mm MIN.
SHIELD:
*2.54 MICROMETER NICKEL OVER 1.27 MICROMETER COPPER UNDERPLATE
PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS AND/OR SHIELD.
3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43743-0001.
4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES TO BE PACKAGED USING TAPE & REEL SYSTEM PER PACKAGING DRAWING PK-70873-7006.
△5 COPLANARITY SPECIFICATION:
WHEN AN ASSEMBLY IS PLACED UPON A LEVEL SURFACE, THE MAXIMUM GAP BETWEEN THE LEVEL SURFACE AND ALL TERMINAL TAILS AND FRONT SOLDER TAB IS 0.15 mm.
△6 THRU HOLES 2.39±0.05 mm ARE FOR SHIELDS WITH LOCATION TABS ONLY.
△7 AVAILABLE WITH (4) OPTIONAL SIDE GROUND TABS (OMITTED FOR SIDE TO SIDE STACKABILITY).
△8 AVAILABLE WITH (2) OPTIONAL LOCATION TABS FOR LOCATING COMPONENT TO PCB AND/OR GROUNDING TO PCB.
9) FOR ASSEMBLIES HAVING VOIDED CIRCUITS, THE TAIL PORTION IS CUT AND REMOVED. THE MATING PORTION OF THE TERMINAL REMAINS INTACT.
10) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
11) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.









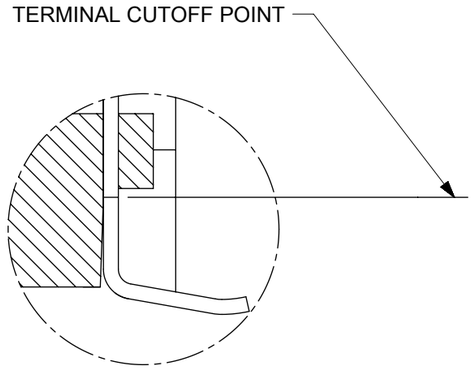
	44282-1004	A	NO	NO	YES	NONE
X	44282-0012	C	NO	YES	NO	NONE
X	44282-0011	B	NO	YES	NO	NONE
X	44282-0010	A	NO	YES	NO	NONE
X	44282-0009	C	YES	YES	NO	NONE
X	44282-0008	B	YES	YES	NO	NONE
X	44282-0007	A	YES	YES	NO	NONE
X	44282-0006	C	NO	YES	YES	NONE
X	44282-0005	B	NO	YES	YES	NONE
X	44282-0004	A	NO	YES	YES	NONE
X	44282-0003	C	YES	YES	YES	NONE
X	44282-0002	B	YES	YES	YES	NONE
	44282-0001	A	YES	YES	YES	NONE
"X"=NOT TOOLED	ASSEMBLY MAT. NO.	TERMINAL PLATING	SHIELD SIDE TABS	SHIELD TOP TABS	LOCATION TABS	VOIDED CIRCUITS

44282-0001, 44282-0002
& 44282-0003 SHOWN

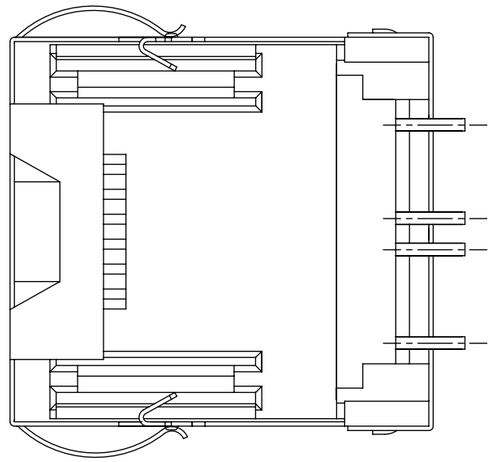
SYMBOLS	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
▽E = 0	DIMENSION UNITS: MM	SCALE: 3:1	CURRENT REV DESC: MIGRATED TO NX	molex	
▽E = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)			SINGLE PORT, SHIELDED SIZE 8, 8 CIRCUIT SMT MODJACK	
▽E = 0	ANGULAR TOL ± 0.5°		EC NO: 173578		
▽S = 0	4 PLACES ±		DRWN: VK10 2018/01/18	PRODUCT CUSTOMER DRAWING	
▼ = 0	3 PLACES ±		CHK'D: KLANG 2018/03/23	DOCUMENT NUMBER: SD-44282-001	DOC TYPE: PSD
▽C = 0	2 PLACES ± 0.25		APPR: KLANG 2018/03/23		DOC PART: 001
☒ = 0	1 PLACE ±		INITIAL REVISION:		REVISION: D5
■ = 0	0 PLACES ±		DRWN: STAMBAUG 99/06/03		
▽ = 0	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		APPR: EDGLEY 99/06/03		
	THIRD ANGLE PROJECTION	DRAWING: A3-SIZE	SERIES: 44282	MATERIAL NUMBER: SEE CHART	CUSTOMER: GENERAL MARKET
					SHEET NUMBER: 1 OF 2

DOCUMENT STATUS	P1	RELEASE DATE	2018/03/23 01:56:29

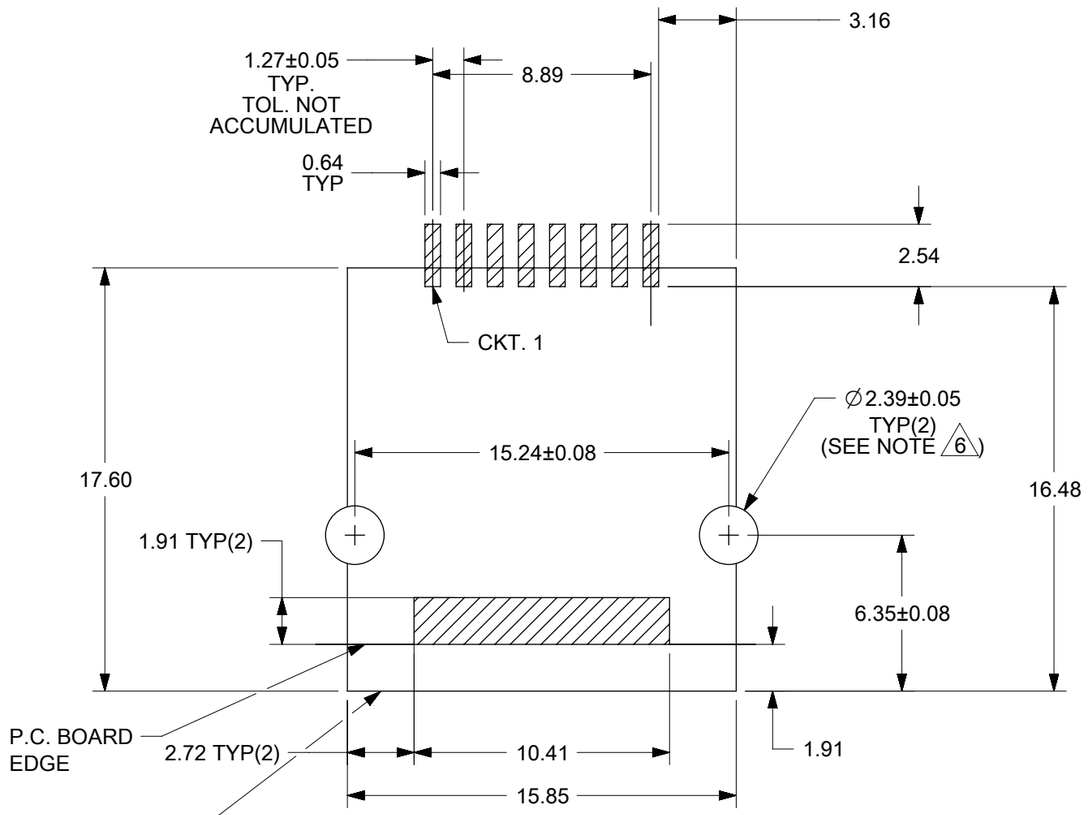
FORMAT: master-tb-prod-A3
REVISION: H
DATE: 2017/10/06



VIEW SHOWING TYPICAL TERMINAL
CUTOFF OF TAIL (SEE NOTE 10) FOR VOIDED CIRCUITS.



TYPICAL VIEW SHOWING VOIDED CIRCUIT
(CIRCUITS 2,3,6 & 7 SHOWN VOIDED)



PC BOARD LAYOUT FOR 8 POSITION HOUSING

(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED MINIMUM PCB THICKNESS: 0.86 mm.

DOCUMENT STATUS	P1	RELEASE DATE	2018/03/23 01:56:29					

FORMAT: master-tb-prod-A3
REVISION: H
DATE: 2017/10/06

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SYMBOLS		
F = 0	DIMENSION UNITS	SCALE
E = 0	MM	1:1
D = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)	
S = 0	ANGULAR TOL ± 0.5 °	
▼ = 0	4 PLACES ±	
C = 0	3 PLACES ±	
☒ = 0	2 PLACES ± 0.25	
■ = 0	1 PLACE ±	
▽ = 0	0 PLACES ±	
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

CURRENT REV DESC: MIGRATED TO NX

EC NO:	173578	
DRWN:	VK10	2018/01/18
CHK'D:	KLANG	2018/03/23
APPR:	KLANG	2018/03/23
INITIAL REVISION:		
DRWN:	STAMBAUG	99/06/03
APPR:	EDGLEY	99/06/03

THIRD ANGLE PROJECTION | DRAWING: A3-SIZE | SERIES: 44282

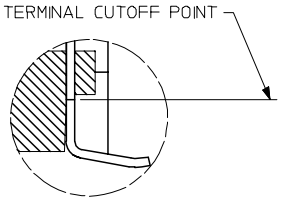
molex

SINGLE PORT, SHIELDED
SIZE 8, 8 CIRCUIT SMT MODJACK

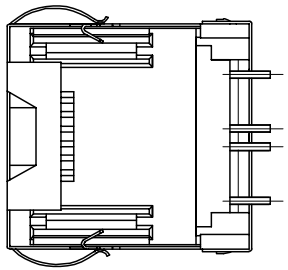
PRODUCT CUSTOMER DRAWING

DOCUMENT NUMBER	DOC TYPE	DOC PART	REVISION
SD-44282-001	PSD	001	D5

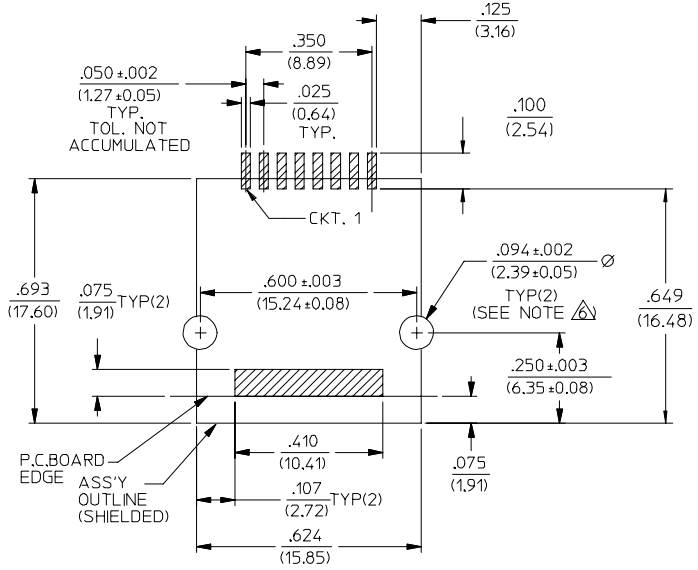
MATERIAL NUMBER	CUSTOMER	SHEET NUMBER
SEE CHART	GENERAL MARKET	2 OF 2



VIEW SHOWING TYPICAL TERMINAL
CUTOFF OF TAIL (SEE NOTE 10) FOR VOIDED CIRCUITS.



TYPICAL VIEW SHOWING VOIDED CIRCUIT
(CIRCUITS 2,3,6 & 7 SHOWN VOIDED)



PC BOARD LAYOUT FOR
8 POSITION HOUSING

(COMPONENT SIDE OF BOARD)

NOTES:
1. RECOMMENDED MINIMUM PCB THICKNESS: .034/0.86

SEE SHEET ONE
EC NO: UCP2008-0143 2007/07/24
DRWN: JBELL 2007/07/30
CH'KD: LSCHMIDT 2007/08/01
APPR: FSMITH
DESCRIPTION
REV
D2

QUALITY SYMBOLS
▼=0
▽=0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± .010
2 PLACES	± 0.25	± ---
1 PLACE	± ---	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: IN/MM
SCALE: 4:1
DESIGN UNITS: INCH
THIRD ANGLE PROJECTION

DRAWN BY	STAMBAUG	DATE 99/06/03
CHECKED BY	WIRKUS	DATE 99/06/03
APPROVED BY	EDGLEY	DATE 99/06/03

TITLE: SURFACE MOUNT MODULAR JACK W/ SHIELD

MOLEX INCORPORATED

MATERIAL NO.: SEE CHART
DOCUMENT NO.: SD-44282-001
SHEET NO.: 2 OF 2

SIZE: C

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